

# FCPF400N80Z N-Channel SuperFET<sup>®</sup> II MOSFET 800 V, 14 A, 400 mΩ

### Features

- Typ. R<sub>DS(on)</sub> = 340 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 43 nC)
- Low E<sub>oss</sub> (Typ. 4.1 uJ @ 400 V)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 138 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

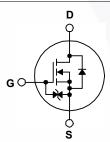
## Applications

- AC-DC Power Supply
- LED Lighting

## Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		Parameter	FCPF400N80Z	Unit		
V <sub>DSS</sub>	Drain to Source Voltage	800	V			
V <sub>GSS</sub>		- DC		±20	V	
	Gate to Source Voltage	- AC	±30	V		
ID	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		14*	Α	
		- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		8.9*	A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	33*	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	339	mJ	
I <sub>AR</sub>	Avalanche Current		(Note 1)	2.2	A	
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	0.36	mJ	
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20		
P <sub>D</sub>	Rower Dissinction	(T <sub>C</sub> = 25°C)		35.7	W	
	Power Dissipation	- Derate Above 25°C		0.29	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

\*Drain current limited by maximum junction temperature, with heatsink.

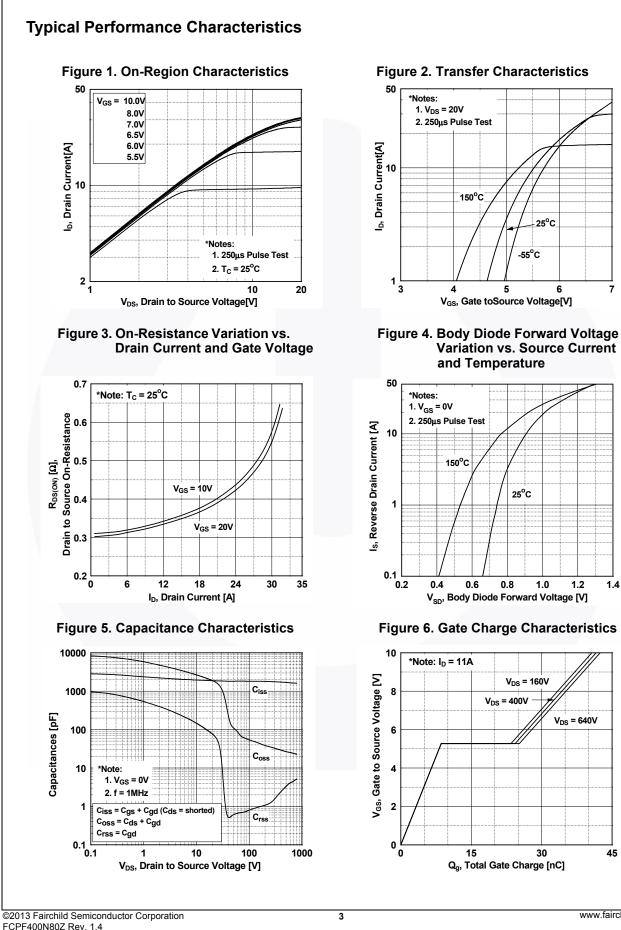
#### Thermal Characteristics

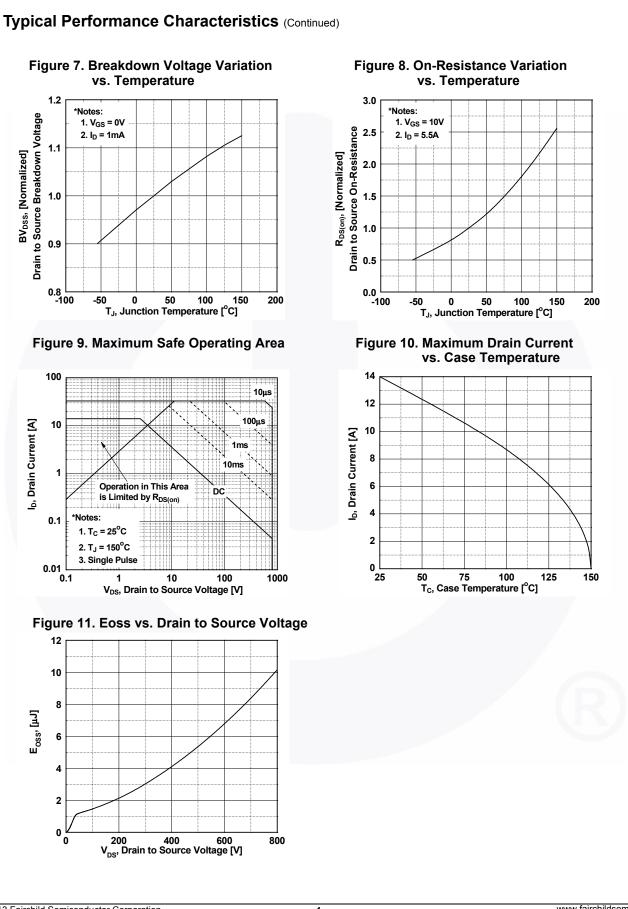
Symbol	Parameter	FCPF400N80Z	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	3.5	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W

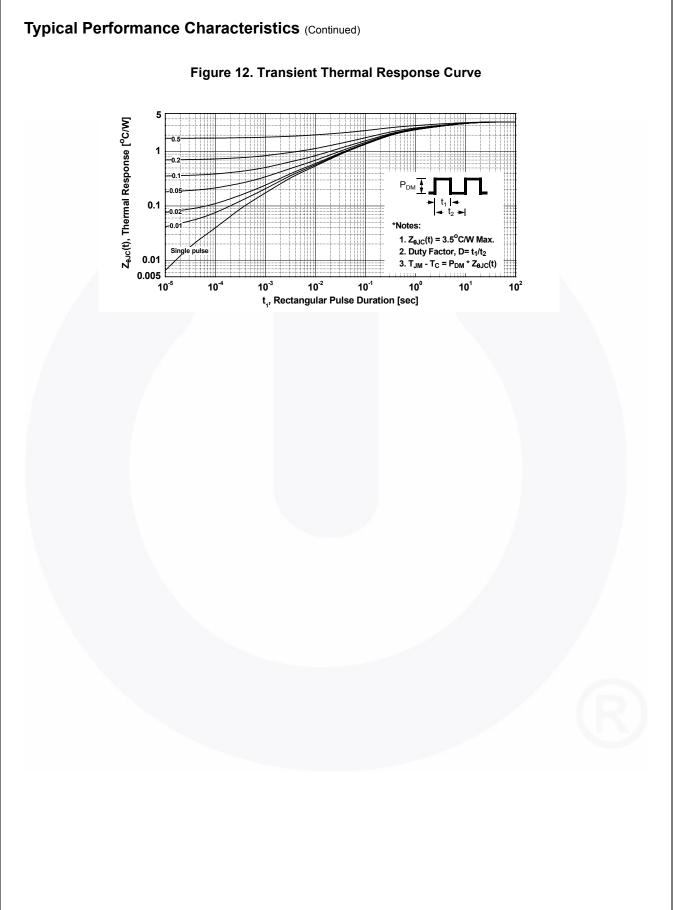
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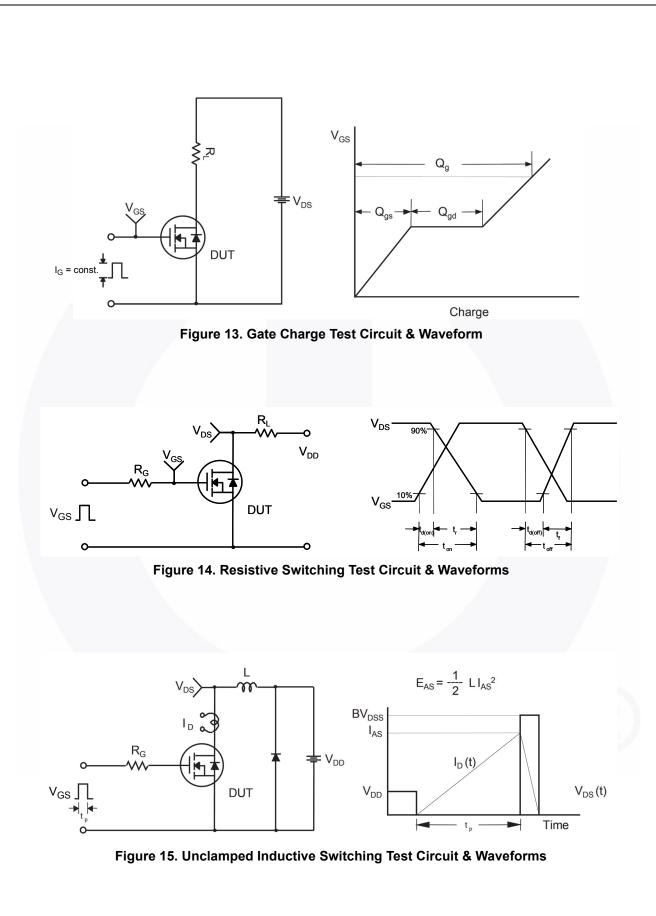
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Part Nu	mber	Top Mark	Package	Packing Method	Reel Siz	e .	Tape Width	Qu	antity	
FCPF40	0N80Z	FCPF400N80Z	TO-220F	Tube	N/A		N/A	50	50 units	
Electrica	al Char	acteristics T <sub>c</sub> = 25	°C unless oth	nerwise noted.				U		
Symbol		Parameter		Test Condition	S	Min.	Тур.	Max.	Unit	
Off Chara	ctoristic	e								
BV <sub>DSS</sub>		-	70 V.	$= -0 V = -1 m \Lambda T$	- 25°C	800	-	-	V	
∆BV <sub>DSS</sub>		Drain to Source Breakdown Voltage $V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 25^{\circ}C$ Breakdown Voltage TemperatureI = 1 mA, Deferenced to 25^{\circ}C			000	-	-			
$/\Delta T_{J}$	Coefficient		I <sub>D</sub>	$I_D = 1 \text{ mA}$ , Referenced to $25^{\circ}C$		-	0.8	-	- V/º0	
	Zero Gate Voltage Drain Current		VD	$V_{DS} = 800 V, V_{GS} = 0 V$ $V_{DS} = 640 V, T_{C} = 125^{\circ}C$		-	-	25		
IDSS			VD			-	-	250	μΑ	
I <sub>GSS</sub>	Gate to	Gate to Body Leakage Current $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			-	-	±10	μA		
On Chara	stariatia				1					
On Chara		-								
V <sub>GS(th)</sub>		nreshold Voltage		$S_{S} = V_{DS}, I_{D} = 1.1 \text{ mA}$		2.5	-	4.5	V	
R <sub>DS(on)</sub>		rain to Source On Resista	C	$_{\rm SS} = 10 \text{ V}, \text{ I}_{\rm D} = 5.5 \text{ A}$		-	0.34	0.4	Ω	
9fs	Forward	d Transconductance	VC	<sub>os</sub> = 20 V, I <sub>D</sub> = 5.5 A		-	12	-	S	
Dynamic (	Characte	eristics								
C <sub>iss</sub>	-	apacitance				-	1770	2350	рF	
C <sub>oss</sub>		Capacitance				-	51	70	pF	
C <sub>rss</sub>		e Transfer Capacitance	f =			1	0.5	-	pF	
C <sub>oss</sub>		Capacitance	Vr	<sub>os</sub> = 480 V, V <sub>GS</sub> = 0 V,	f = 1 MHz	-	28	-	pF	
C <sub>oss(eff.)</sub>		e Output Capacitance		$_{\rm OS} = 0$ V to 480 V, V <sub>GS</sub>		-	138	-	pF	
Q <sub>g(tot)</sub>		ate Charge at 10V		<sub>DS</sub> = 640 V, I <sub>D</sub> = 11 A,		-	43	56	nC	
Q <sub>gs</sub>		Source Gate Charge		$_{3S} = 10 V$	-	-	8.6	-	nC	
Q <sub>gd</sub>	Gate to	Drain "Miller" Charge		(Note 4)		-	17	-	nC	
ESR	Equivale	ent Series Resistance	f =	1 MHz		-	2.3	-	Ω	
0	Ohamaa	4								
Switching										
t <sub>d(on)</sub>		Delay Time	V	$V_{DD}$ = 400 V, I <sub>D</sub> = 11 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 4.7 Ω		-	20	50	ns	
t <sub>r</sub>		Rise Time				-	12	34	ns	
t <sub>d(off)</sub>		f Delay Time	•6			-	51	112	ns	
t <sub>f</sub>	Turn-Of	f Fall Time			(Note 4)	-	2.6	15	ns	
Drain-Sou	rce Dio	de Characteristics								
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current				-	14	Α			
I <sub>SM</sub>		m Pulsed Drain to Source				-	-	33	Α	
V <sub>SD</sub>	Drain to	Source Diode Forward Vo	ltage V <sub>G</sub>	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 11 A		-	-	1.2	V	
t <sub>rr</sub>		Recovery Time		V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 11 A, dI <sub>F</sub> /dt = 100 A/μs		-	395	-	ns	
	Reverse	e Recovery Charge				-	7.4	-	μC	
	g: pulse-width	<ul> <li>Recovery Charge</li> <li>Iimited by maximum junction temp</li> <li>25 Ω, starting T<sub>J</sub> = 25°C.</li> </ul>		c/dt = 100 A/μs		•	7.4	Í		



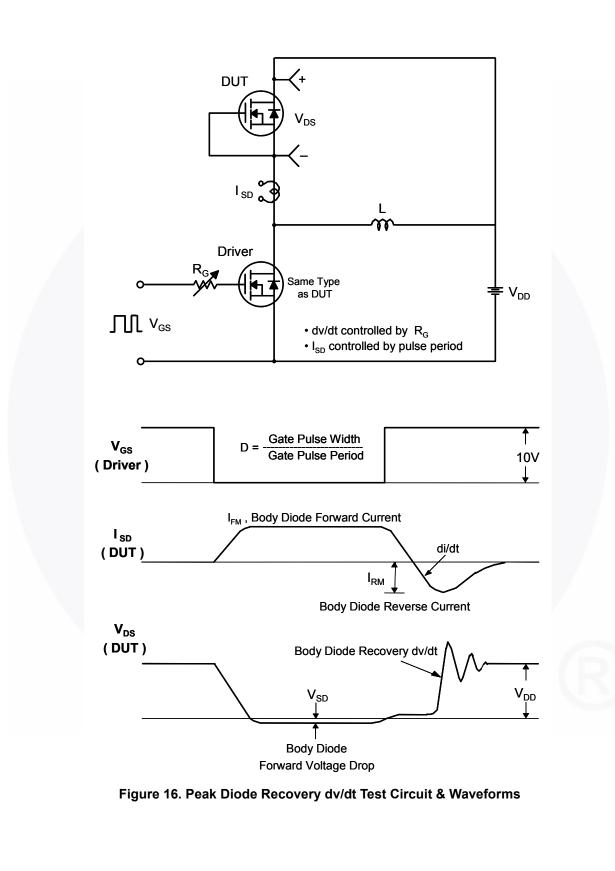


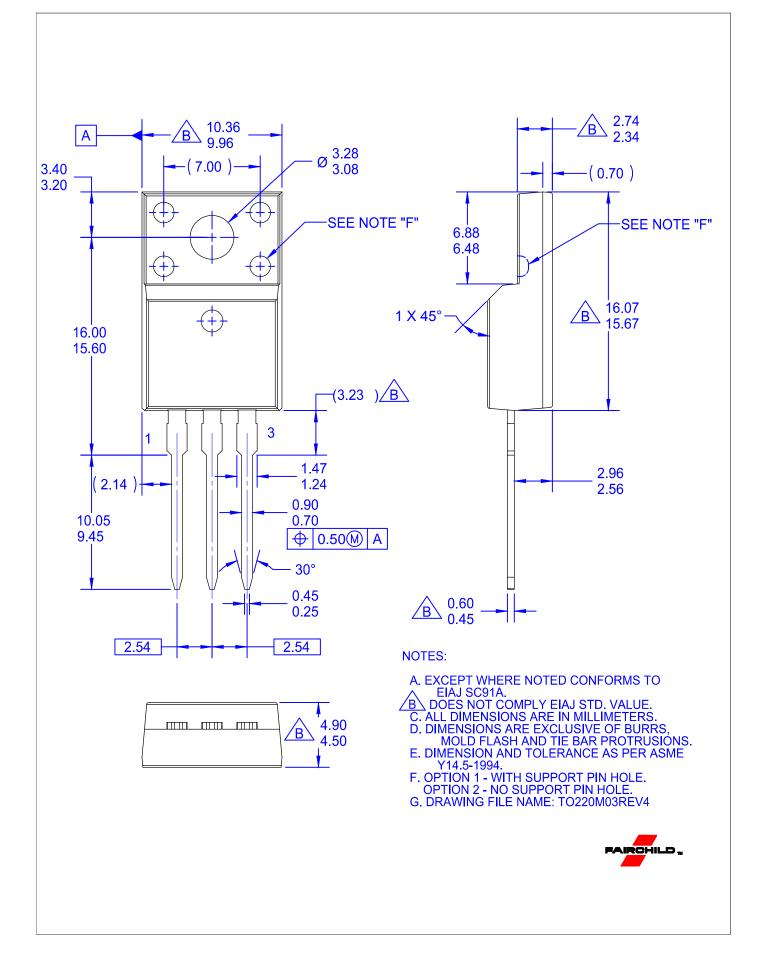




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